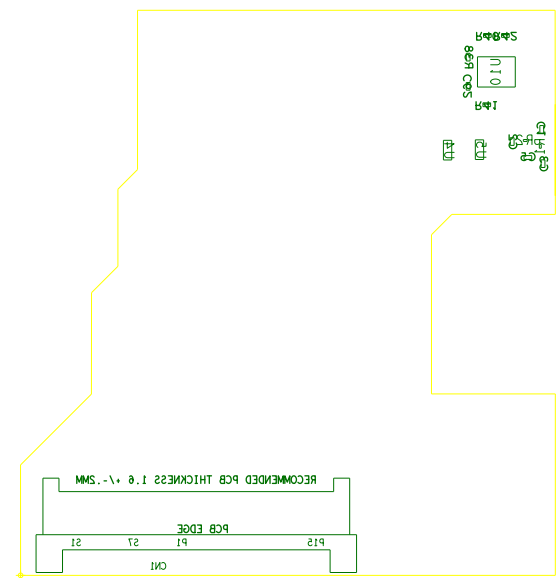
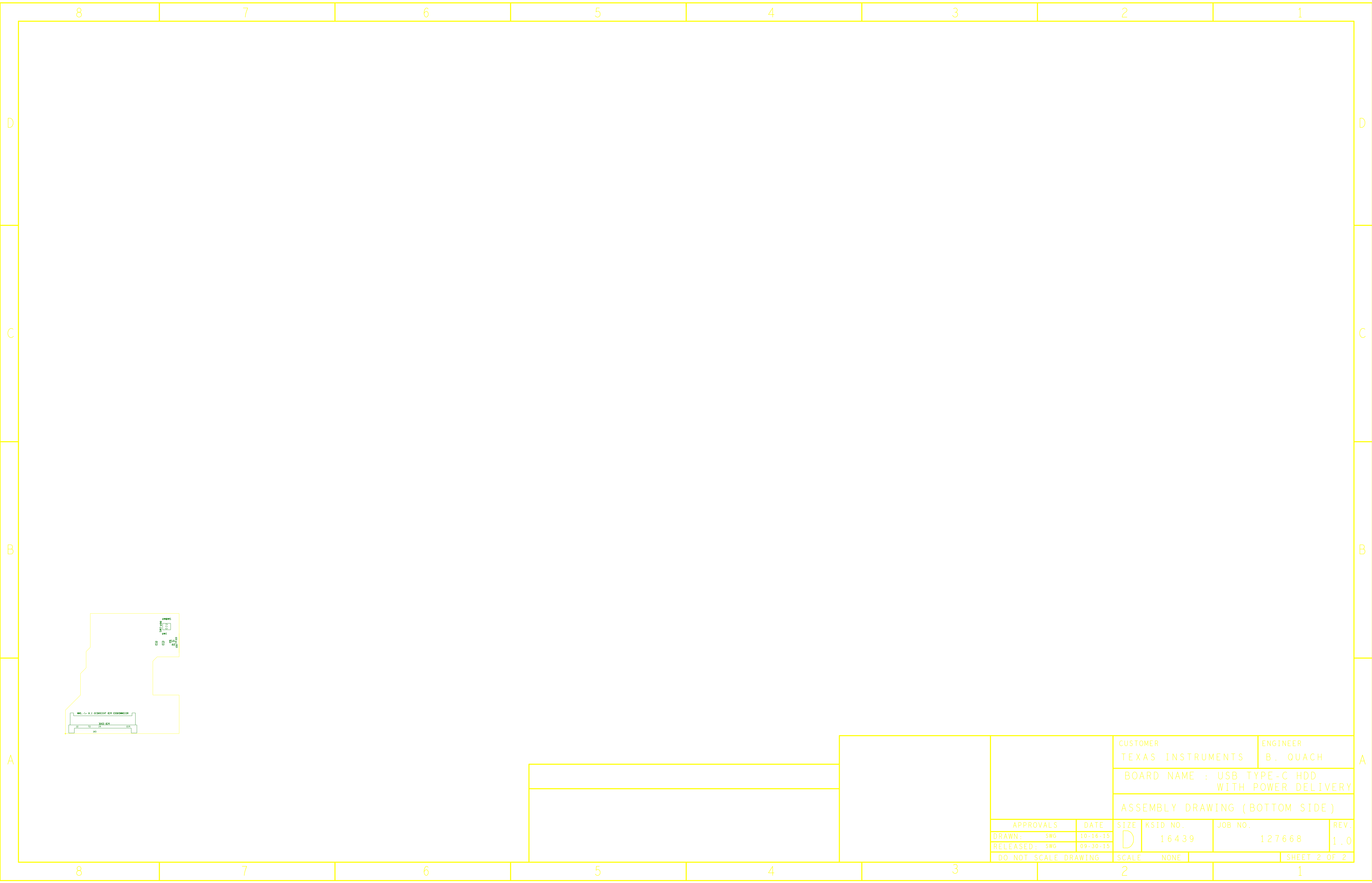


APPROVALS		DATE	SIZE	KSID NO.	JOB NO.	REV.
DRAWN: SWG		10-16-15	D	16439	127668	1.0
RELEASED: SWG		09-30-15				
DO NOT SCALE DRAWING			SCALE	NONE	SHEET 1 OF 2	

CUSTOMER TEXAS INSTRUMENTS	ENGINEER B. QUACH
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BOARD NAME : USB TYPE-C HDD  
WITH POWER DELIVERY

ASSEMBLY DRAWING (TOP SIDE)



		CUSTOMER TEXAS INSTRUMENTS		ENGINEER B. QUACH	
		BOARD NAME : USB TYPE-C HDD WITH POWER DELIVERY			
		ASSEMBLY DRAWING (BOTTOM SIDE)			
APPROVALS	DATE	SIZE	KSID NO.	JOB NO.	REV.
DRAWN: SWG	10-16-15	D	16439	127668	1.0
RELEASED: SWG	09-30-15				
DO NOT SCALE DRAWING		SCALE	NONE	SHEET 2 OF 2	

8 7 6 5 4 3 2 1

D D

C C

B B

A A

8 7 6 5 4 3 2 1

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